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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/711,764	10/04/2004	Toshiharu Furukawa	BUR920040152US1	5763
37692 75	590 12/13/2005	EXAMINER		INER
WOOD, HERRON & EVANS, LLP (IBM-BUR)			STARK, JARRETT J	
	700 CAREW TOWER 41 VINE STREET		ART UNIT	PAPER NUMBER
CINCINNATI, OH 45202			2823	
			DATE MAILED: 12/13/2009	5

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)				
Office Action Summary		10/711,764	FURUKAWA ET AL.				
		Examiner	Art Unit				
		Jarrett J. Stark	2823				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address							
Period for f		LO OET TO EVENE AMONTH	, C) OD TUIDTY (20) DAYS				
WHICH - Extension after SIX - If NO pe - Failure to Any repl	EVER IS LONGER, FROM THE MAILING DATE on softime may be available under the provisions of 37 CFR 1.13 (6) MONTHS from the mailing date of this communication. Friod for reply is specified above, the maximum statutory period we reply within the set or extended period for reply will, by statute, y received by the Office later than three months after the mailing patent term adjustment. See 37 CFR 1.704(b).	TE OF THIS COMMUNICATION 6(a). In no event, however, may a reply be time ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. hely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status							
1)□ R	esponsive to communication(s) filed on 04 Oc	ctober 2004.					
•	This action is FINAL. 2b)⊠ This action is non-final.						
•	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.							
Disposition	n of Claims						
4)⊠ Claim(s) <u>1-23</u> is/are pending in the application.							
4a	4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.							
· —	6)⊠ Claim(s) <u>1-23</u> is/are rejected.						
•	7) Claim(s) is/are objected to.						
8)∐ C	laim(s) are subject to restriction and/or	r election requirement.					
Application	n Papers						
¥ = ·	ne specification is objected to by the Examine						
10)⊠ The drawing(s) filed on <u>04 October 2004</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.							
	pplicant may not request that any objection to the						
	eplacement drawing sheet(s) including the correct						
11)[_] TI	ne oath or declaration is objected to by the Ex	aminer. Note the attached Office	ACTION OF JOHN PTO-132.				
Priority un	der 35 U.S.C. § 119						
12) 🗌 Ad	cknowledgment is made of a claim for foreign	priority under 35 U.S.C. § 119(a	i)-(d) or (f).				
a) <u></u>	All b) Some * c) None of:						
1. Certified copies of the priority documents have been received.							
<u>_</u>	 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage 						
3			ed in this Hational Otago				
application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.							
Jee the attached detailed Office action for a fist of the continua copies not reserve.							
Attachment(s		4) Interview Summar	v (PTO-413)				
· ·	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail C	Date				
3) 🔲 Informa	ation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) No(s)/Mail Date	5) Notice of Informal 6) Other:	Patent Application (PTO-152)				

DETAILED ACTION

Election/Restrictions

Claims 24-45 withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected method of manufacturing a semiconductor device, there being no allowable generic or linking claim. Election was made **without** traverse in the reply filed on 12/01/2005.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1, 2, 4, 5, 9, & 10 are rejected under 35 U.S.C. 102(e) as being anticipated by Lyons et al. (US 6,790,790).

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Regarding claim 1, Lyons discloses a dielectric material for forming a structure of an integrated circuit, said dielectric material comprising a plurality of carbon nanostructures. (Lyons, col. 2 lines 61-67 & Lyons, col. 3, lines 30-35)

Regarding claim 2, <u>Lyons</u> discloses the dielectric material of claim 1 wherein said carbon nanostructures comprise a plurality of carbon nanotubes. (<u>Lyons</u>, col. 3, lines 30-35)

Regarding claim 4, Lyons discloses the dielectric material of claim 1 wherein said dielectric material has a dielectric constant of less than about 3. (Lyons, col. 2 lines 61-67)

Regarding claim 5, Lyons discloses the dielectric material of claim 1 wherein said structure further comprises at least one conductive feature disposed in said dielectric material. (Lyons, col. 4, lines 41-54)

Regarding claim 9, Lyons discloses the dielectric material of claim 1 further comprising:

a copolymer layer binding said carbon nanostructures to define the dielectric material. (<u>Lyons</u>, col. 3, lines 4-28)

Regarding claim 10, Lyons discloses the dielectric material of claim 7 wherein said carbon nanostructures and said copolymer layer have an effective dielectric constant of less than about 3. (Lyons, col. 2 lines 61-67)

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Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:

- 1. Determining the scope and contents of the prior art.
- 2. Ascertaining the differences between the prior art and the claims at issue.
- 3. Resolving the level of ordinary skill in the pertinent art.
- 4. Considering objective evidence present in the application indicating obviousness or nonobviousness.

Claims 7, 8, 11-13, 15,16, & 18-23 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lyons et al. (US 6,790,790) in view of Nguyen et al. (US 2004/0169281).

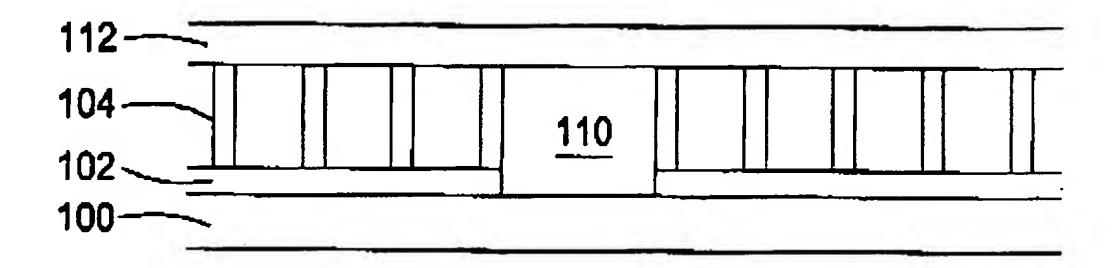
Regarding claim 7, Lyons discloses the dielectric material of claim 1.

Lyons does not disclose the device further comprising a cap layer on said dielectric material.

(Lyons, col. 4, lines 41-54)

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Nguyen discloses a device made up of a low-k carbon nanotube material further comprising a cap layer on said dielectric material. (Nguyen, [0020] & Fig. 1C)



Therefore it would be obvious to one of ordinary skill in the art at the time of the invention to add a cap layer. The cap layer may be a silicon oxide layer or another dielectric layer. (Nguyen, [0035]

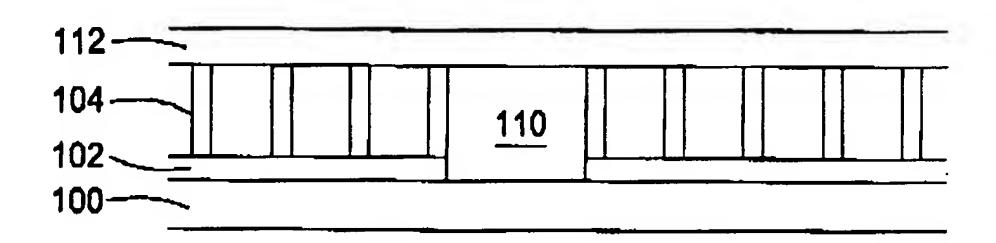
Regarding claim 8, Lyons in view of Nguyen disclose the dielectric material of claim 7 wherein said carbon nanostructures and said cap layer have an effective dielectric constant of less than about 3. (Lyons, col. 2 lines 61-67)

Regarding claim 11, Lyons in view of Nguyen disclose the semiconductor structure formed on a substrate, comprising:

a dielectric layer comprising a plurality of carbon nanostructures; and (<u>Lyons</u>, col. 3, lines 30-35)
at least one conductive feature in said dielectric layer, said conductive feature electrically isolated from nearby conductive features by portions of said dielectric layer.

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Regarding claim 12, Lyons in view of Nguyen disclose the semiconductor structure of claim 11 wherein said dielectric layer has an exposed surface, and further comprising: a cap layer of an insulating material at least partially covering said exposed surface, said cap layer having (Nguyen Fig. 1C, 112) a top surface, and said conductive feature (Nguyen Fig. 1C, 110) having a top surface substantially coplanar with said top surface of said cap layer (Nguyen Fig. 1C, 112).

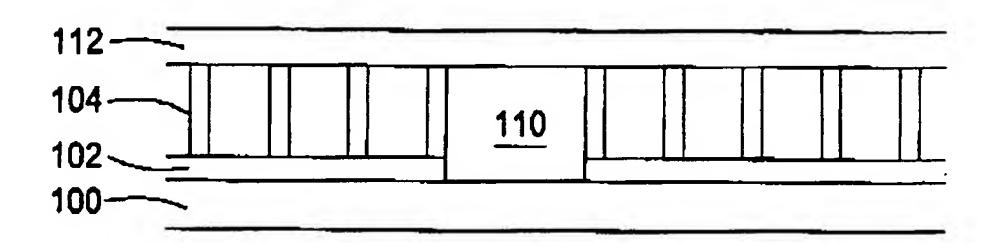


Regarding claim 13, Lyons in view of Nguyen disclose the semiconductor structure of claim 11 wherein said carbon nanostructures comprise a plurality of carbon nanotubes. (Lyons, col. 3, lines 30-35)

Regarding claim 15 Lyons in view of Nguyen disclose the semiconductor structure of claim 11 wherein said dielectric layer has a dielectric constant of less than about 3. (Lyons, col. 2 lines 61-67)

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Regarding claim 16 Lyons in view of Nguyen disclose the semiconductor structure of claim 11 wherein said structure comprises a plurality of conductors (Nguyen Fig. 1C, 110) electrically isolated by said layer of said dielectric material (Nguyen Fig. 1C, 104).



Regarding claim 18 Lyons in view of Nguyen disclose the semiconductor structure of claim 11 further comprising:

a cap layer (Nguyen Fig. 1C, 112). disposed on said carbon nanostructures.

Regarding claim 19 Lyons in view of Nguyen disclose the semiconductor structure of claim 18 wherein said carbon nanostructures and said cap layer collectively have a dielectric constant of less than about 3. (Lyons, col. 2 lines 61-67)

Regarding claim 20 Lyons in view of Nguyen disclose the semiconductor structure of claim 11 further comprising:

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a substrate selected from the group consisting of an interconnect level, a dielectric material, a buried barrier layer, a metallization line, and a semiconductor wafer.

(Lyons, col. 4, lines 41-54) & (Nguyen Fig. 1C)

Regarding claim 21 Lyons in view of Nguyen disclose the integrated circuit comprising a plurality of circuit elements and the semiconductor structure of claim 11, said conductive feature being electrically coupled with at least one of said circuit elements. (Lyons, col. 4, lines 41-54)

Regarding claim 22 Lyons in view of Nguyen disclose the dielectric material of claim 11 further comprising:

a copolymer layer binding said carbon nanostructures to define said dielectric layer. (Lyons, col. 3, lines 4-28)

Regarding claim 22 Lyons in view of Nguyen disclose the dielectric material of claim 22 wherein said carbon nanostructurse and said copolymer layer have an effective dielectric constant of less than about 3. (Lyons, col. 2 lines 61-67)

Claims 3, & 6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lyons et al. (US 6,790,790) in view of <u>Dahl et al.</u> (US 2002/0130407).

Regarding claims 3 & 6, Lyons discloses the dielectric material of claim 1.

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Lyons does not teach wherein said carbon nanostructures comprise a plurality of fluorinated carbon nanotubes or

... wherein said carbon nanostructures comprise a plurality of fluorinated carbon buckyballs.

<u>Dahl</u> teaches the use of fluorinated amorphous carbon formed by conventional CVD techniques which lead to a film with a lower (and therefore more desirable) dielectric constant. (<u>Dahl</u>, [0135])

Therefore it would be obvious to one of ordinary skill in the art at the time of the invention to use fluorinated carbon for nanotubes and buckyballs when making a low-k dielectric film.

Fluorinated amorphous carbon (FLAC, or .alpha.-CF), has a dielectric constant in the range 2.3 to 2.7. (<u>Dahl</u>, [0133])

Claims 14, &17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lyons et al. (US 6,790,790) in view of Nguyen et al. (US 2004/0169281) in further view of Dahl et al. (US 2002/0130407).

Regarding claims 14 & 17, Lyons et al. in view of Nguyen et al., disclose the dielectric material of claim 11.

Lyons does not teach wherein said carbon nanostructures comprise a plurality of fluorinated carbon nanotubes, or

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... wherein said carbon nanostructures comprise a plurality of fluorinated carbon buckyballs.

<u>Dahl</u> teaches the use of fluorinated amorphous carbon formed by conventional CVD techniques which lead to a film with a lower (and therefore more desirable) dielectric constant. (<u>Dahl</u>, [0135])

Therefore it would be obvious to one of ordinary skill in the art at the time of the invention to use fluorinated carbon for nanotubes and buckyballs when making a low-k dielectric film.

Fluorinated amorphous carbon (FLAC, or .alpha.-CF), has a dielectric constant in the range 2.3 to 2.7. (<u>Dahl</u>, [0133])

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jarrett J. Stark whose telephone number is (571) 272-6005. The examiner can normally be reached on Monday - Thursday 7:00AM - 5:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith can be reached on (571) 272-1907. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

JJS December 5, 2005

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